


VN1206
VN1210

N-Channel Enhancement-Mode
Vertical DMOS Power FETs

T-39-05

Ordering Information

$BV_{DSS} /$ BV_{DGS}	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)	Order Number / Package		
			TO-39	TO-92	TO-220
120V	6Ω	1.0A	VN1206B	VN1206L	VN1206D
120V	10Ω	1.0A	VN1210B	VN1210L	VN1210D

Features

- ☐ Freedom from secondary breakdown
- ☐ Low power drive requirement
- ☐ Ease of paralleling
- ☐ Low C_{iss} and fast switching speeds
- ☐ Excellent thermal stability
- ☐ Integral Source-Drain diode
- ☐ High input impedance and high gain
- ☐ Complementary N- and P-Channel devices

Advanced DMOS Technology

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Applications

- ☐ Motor control
- ☐ Converters
- ☐ Amplifiers
- ☐ Switches
- ☐ Power supply circuits
- ☐ Drivers (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

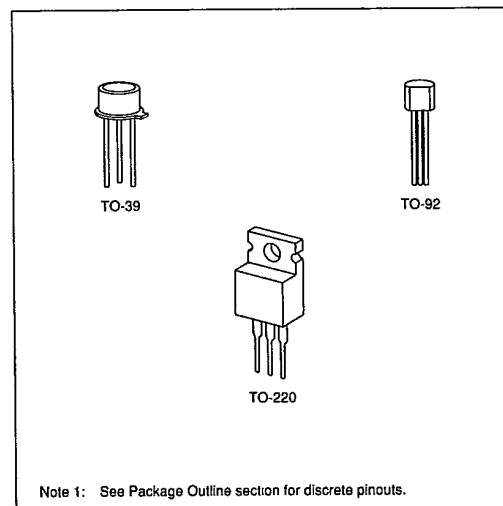
Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	±40V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

*Distance of 1.6 mm from case for 10 seconds.

Package Options

(Note 1)



Thermal Characteristics

T-39-05

Package	I_D (continuous)*	I_D (pulsed)	Power Dissipation	θ_{JA} °C/W	θ_{JC} °C/W
TO-39	0.7A	3.0A	6.25W	170	21
TO-92	0.1A	0.6A	.4W	312.5	21.3
TO-220	1.5A	3.0A	45W	80	6.25

* I_D (continuous) is limited by max rated T_J .

Electrical Characteristics (@ 25°C unless otherwise specified)

(Notes 1 and 2)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	120			V	$I_D = 100\mu A$, $V_{GS} = 0$
$V_{GS(th)}$	Gate Threshold Voltage	0.8		2.0	V	$V_{GS} = V_{DS}$, $I_D = 1mA$
I_{GSS}	Gate Body Leakage			100	nA	$V_{GS} = \pm 15V$, $V_{DS} = 0$
I_{DSS}	Zero Gate Voltage Drain Current			10	μA	$V_{GS} = 0$, $V_{DS} = 120V$
				500		$V_{GS} = 0$, $V_{DS} = 120V$
						$T_A = 125^\circ C$
$I_{D(ON)}$	ON-State Drain Current	1.0			A	$V_{GS} = 10V$, $V_{DS} \geq 2 V_{DS(ON)}$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance	ALL		10	Ω	$V_{GS} = 2.5V$, $I_D = 0.1A$
		VN1206		6		$V_{GS} = 10V$, $I_D = 0.5A$
		VN1210		10		$I_D = 0.5A$, $V_{GS} = 10V$
G_{FS}	Forward Transconductance	300			mU	$V_{DS} \geq 2 V_{DS(ON)}$, $I_D = 0.5A$
C_{ISS}	Input Capacitance			125	pF	$V_{GS} = 0$, $V_{DS} = 25V$ $f = 1MHz$
C_{OSS}	Common Source Output Capacitance			50		
C_{RSS}	Reverse Transfer Capacitance			20		
$t_{(ON)}$	Turn-ON Time			16	ns	$V_{DD} = 60V$, $I_D = 0.1A$ $R_S = 50\Omega$
$t_{(OFF)}$	Turn-OFF Time			57		
V_{SD}	Diode Forward Voltage Drop	VN1210	-1.2		V	$I_{SD} = -.12A$, $V_{GS} = 0$
		VN1206	-1.2		V	$I_{SD} = -.25A$, $V_{GS} = 0$

Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)

Note 2: All A.C. parameters sample tested.

Switching Waveforms and Test Circuit

